Optical Transport Network (OTN) has emerged as the physical layer interface protocol of choice for carriers to transport a variety of services over a single optical fiber. Microsemi offers the widest portfolio of single-chip devices delivering "any frequency, any port" performance for OTN.

| Part     | DPLLs<br>or<br>Paths | DPLL<br>BW<br>(Hz) | Inputs        | Diff.<br>Outputs | CMOS<br>Outputs | Low-<br>Jitter<br>APLLs | GP<br>Clock<br>Gen | Typ.<br>Jitter<br>(ps <sub>RMS</sub> ) | Input<br>Frequency | Output<br>Frequency | NV<br>Memory | Host<br>Bus | 2K/8K<br>Align | 1 Hz<br>Align | NCO<br>(ppb) | Pkg<br>size<br>(mm) |
|----------|----------------------|--------------------|---------------|------------------|-----------------|-------------------------|--------------------|--|--------------------|---------------------|--------------|-------------|----------------|---------------|--------------|---------------------|
| ZL30152  | 1                    | 14–896             | 2 D/SE        | 4                | 2               | 1                       | 0                  | 0.7                                    | 1 kHz–750 MHz      | 1 kHz–750 MHz       | OTP          | SPI/I2C     |                |               |              | 9 x 9               |
| ZL30155  | 2                    | 14-896             | 4 D/SE        | 8                | 4               | 2                       | 0                  | 0.7                                    | 1 kHz–750 MHz      | 1 kHz–750 MHz       | OTP          | SPI/I2C     |                |               |              | 11 x 11             |
| ZL30157  | 2                    | 14-896             | 4 D/SE        | 8–12             | 4–12            | 1                       | 1                  | 0.7                                    | 1 kHz–750 MHz      | 1 kHz–750 MHz       | OTP          | SPI/I2C     |                |               |              | 11 x 11             |
| ZL30160  | 4                    | 14-896             | 4 D/SE        | 8                | 4–12            | 2                       | 2                  | 0.7                                    | 1 kHz–750 MHz      | 1 kHz–750 MHz       | OTP          | SPI/I2C     |                |               |              | 11 x 11             |
| ZL30165  | 4                    | 5-806              | 8 D/SE        | 8                | 8               | 4                       | 0                  | 0.65                                   | 1 kHz–750 MHz      | 1 Hz–750 MHz        | OTP          | SPI/I2C     |                |               | 0.001        | 13 x 13             |
| MAX24705 | 1                    | 4–400              | 2 D/SE        | 0–5              | 0–10            | 1–2                     | 0                  | 0.35                                   | 2 kHz–750 MHz      | 1 Hz–750 MHz        | Int EE       | SPI         | •              |               | 0.01         | 10 x 10             |
| MAX24710 | 1                    | 4–400              | 2 D/SE        | 0–10             | 0–20            | 1–2                     | 0                  | 0.35                                   | 2 kHz–750 MHz      | 1 Hz–750 MHz        | Int EE       | SPI         | •              |               | 0.01         | 10 x 10             |
| ZL30166  | 3                    | 5–896              | 9 D/SE + 2 SE | 8                | 8               | 4                       | 0                  | 0.65                                   | 1 kHz–750 MHz      | 1 Hz–750 MHz        | OTP          | SPI/I2C     |                | •             | 0.001        | 13 x 13             |
| ZL30167  | 2                    | 5–896              | 9 D/SE + 2 SE | 8                | 8               | 4                       | 0                  | 0.65                                   | 1 kHz–750 MHz      | 1 Hz–750 MHz        | OTP          | SPI/I2C     |                | •             | 0.001        | 13 x 13             |
| ZL30168  | 4                    | 5–896              | 8D/SE         | 8                | 8               | 4                       | 0                  | 0.65                                   | 1 kHz–750 MHz      | 1 Hz–750 MHz        | OTP          | SPI/I2C     |                |               | 0.001        | 13 x 13             |
| ZL30169  | 1                    | 14–500             | 2 D/SE + 2 SE | 3                | 6               | 1                       | 0                  | 0.25                                   | 1 kHz–1250 MHz     | 1 Hz–1035 MHz       | Int EE       | SPI/I2C     | •              |               | 0.01         | 5 x 5               |
| ZL30182  | 2                    | 5–500              | 4 D/SE + 2 SE | 6                | 12              | 2                       | 0                  | 0.25                                   | 1 kHz–1250 MHz     | 1 Hz–1035 MHz       | Int EE       | SPI/I2C     | •              |               | 0.01         | 5 x 10              |
| ZL30174  | 3                    | 14–470             | 5 D/10 SE     | 6                | 14              | 3                       | 1                  | 0.18                                   | 1 kHz–900 MHz      | 1 Hz–900 MHz        | Int EE       | SPI/I2C     | •              | •             |              | 10 x 10             |

## Abbreviations:

APLL= analog phase-locked loop. D/Diff= differential. DPLL= digital phase-locked loop. Freq= frequency. Gen= generator. GP= general purpose. Int. EE= internal EEPROM. Int-N= integer-N (can only multiply by an integer). NCO= numerically controlled oscillator. NV= nonvolatile. OTP= one-time programmable. Ppb= parts per billion. Pkg= package. SE= single-ended (CMOS).

## Inputs:

APLLs are fractional-N unless specified as Int-N. GP clock gen are general-purpose clock generators that make output clock signals with more than 1 ps RMS jitter. 2k/8k align means the part can phase-align all outputs to a 2 kHz or 8 kHz alignment input. 1 Hz align means the part can phase-align all outputs to a 1 Hz alignment input.



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One Enterprise, Aliso Viejo, CA 92656 USA Within the USA: +1 (800) 713-4113 Outside the USA: +1 (949) 380-6100 Fax: +1 (949) 215-4996 Email: sales.support@microsemi.com www.microsemi.com Microsemi Corporation (Nasdaq: MSCC) offers a comprehensive portfolio of semiconductor and system solutions for aerospace & defense, communications, data center and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; enterprise storage and communication solutions, security technologies and scalable anti-tamper products; Ethernet solutions; Power-over-Ethernet ICs and midspans; as well as custom design capabilities and services. Microsemi is headquartered in Aliso Viejo, California and has approximately 4,800 employees globally. Learn more at www.microsemi.com.

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